

Preliminary Amendment

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Serial No.: Unknown

(Priority Application No. DE 102 01 775.1)

(International Application No. PCT/DE03/00083)

Filed: Herewith

(Priority Date January 17, 2002)

(International Filing Date January 14, 2003)

Docket No.: I431.108.101/FIN 317 PCT/US

Title: ELECTRONIC COMPONENT AND PANEL AND METHOD FOR THE PRODUCTION THEREOF

IN THE ABSTRACT

Please replace the Abstract with the following rewritten paragraph:

Abstract**ELECTRONIC COMPONENT AND PANEL AND METHOD FOR
PRODUCING THE SAME****Abstract**

The invention relates to an electronic component and a panel-(36), the electronic component having a semiconductor chip (2)-with a wiring board (3)-and a plastic package-(4). The plastic package (4)-is made up of two layers (5,6)-of plastic package molding compound (23)-arranged one on top of the other. These layers are created with the aid of a printing operation under normal atmosphere.

{Figure 1}